





#### COMPLEMENTARY OUTPUT HALL EFFECT LATCH

## **Description**

AH276 are integrated Hall sensors with output drivers, mainly designed for electronic commutation of brush-less DC Fan. This IC internally includes the regulator, protecting diode, Hall plate, amplifier, comparator, and a pair of complementary open-collector outputs (DO, DOB).

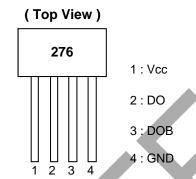
While the magnetic flux density (B) is larger than operate point (Bop), DO will turn on (low), and meanwhile DOB will turn off (high). Each output is latched until B is lower than release point (Brp), and then DO, DOB transfer each state.

For DC fan application, sometimes need to test power reverse connection condition. Internal diode only protects chip-side but not for coil-side. If necessary, add one external diode to block the reverse current from coil-side.

### **Features**

- On-chip Hall sensor with two different sensitivity and hysteresis settings for AH276
- Built-in protecting diode only for chip reverse power connecting
- -20°C to +85°C operating temperature
- Lead Free Package: SIP-4L
- SIP-4L: Available in "Green" Molding Compound (No Br, Sb)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Pin Assignments**



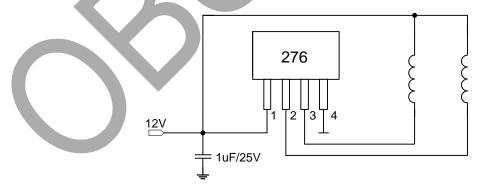
## **Applications**

- Dual-coil Brush-less DC Motor
- Dual-coil Brush-less DC Fan
- Revolution Counting
- Speed Measurement

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

# **Typical Applications Circuit**



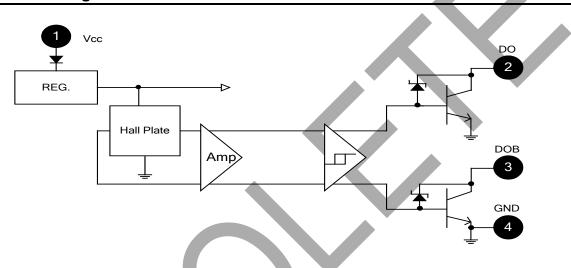
Brush-less DC Fan



# **Pin Descriptions**

Pin Name	P/I/O	Pin#	Function
Vcc	Р	1	Power Supply Input
DO	0	2	Output Pin
DOB	0	3	Output Pin
GND	Р	4	Ground

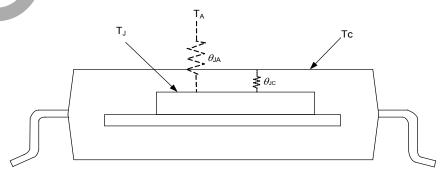
# **Functional Block Diagram**



# Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol		ameter	Rating	Unit
$V_{CC}$	Supply Voltage		20	٧
$V_{RCC}$	Reverse VCC Polarity Voltage		-20	V
В	Magnetic Flux Density		Unlir	mited
	0.15.1 " " 0.55.5	Continuous	0.4	
lo	lo Output "on" Current (Note 3)	Hold	0.5	Α
	(Note 3)	Peak (Start Up)	0.7	
Ts	Storage Temperature Range		-65 ~ +150	°C
PD	Package Power Dissipation (SI	P-4L)	550	mW
TJ	Maximum Junction Temperature		+150	°C
$\theta_{JA}$	Thermal Resistance Junction-to	o-Ambient (SIP-4L)	227	°C/W
θις	Thermal Resistance Junction-to	o-Case (SIP-4L)	49	°C/W

Note: 3. P<sub>D</sub> shall be within Safety Operation Area.





# Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply Voltage (Note 4)	Operating	3.5	20	V
T <sub>A</sub>	Operating Ambient Temperature	Operating	-20	+85	°C

Note: 4. The output DO/DOB is switching as magnetic field change (S>300G, N<-300G).

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Vz	Output Zener Breakdown		ı	35	_	V
V <sub>CE</sub> (SAT)	Output Saturation Voltage	V <sub>CC</sub> = 14V, I <sub>L</sub> = 400mA	_	0.6	0.9	V
I <sub>CEX</sub>	Output Leakage Current	V <sub>CE</sub> = 14V, V <sub>CC</sub> = 14V	_	<0.1	10	μA
Icc	Supply Current	V <sub>CC</sub> = 20V, Output Open	7	16	25	mA

## Magnetic Characteristics (Note 5) (@TA = +25°C, VCC = 14V, unless otherwise specified.)

### A grade

Symbol	Characteristic	Min	Тур	Max	Unit
Вор	Operate Point	10		50	Gauss
Brp	Release Point	-50	_	-10	Gauss
Bhy	Hysteresis	1	75	_	Gauss

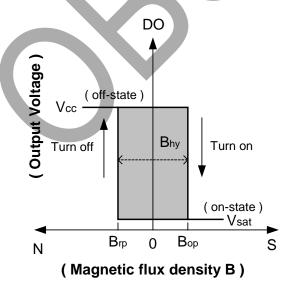
#### B grade

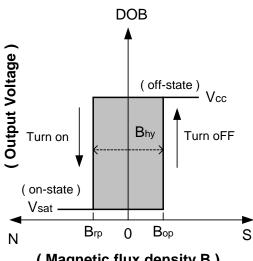
Symbol	Characteristic	Min	Тур	Max	Unit
Вор	Operate Point	5	_	70	Gauss
Brp	Release Point	-70	_	-5	Gauss
Bhy	Hysteresis		75	1	Gauss

#### C grade

Symbol	Characteristic	Min	Тур	Max	Unit
Вор	Operate Point	_	_	100	Gauss
Brp	Release Point	-100	_	_	Gauss
Bhy	Hysteresis	_	75		Gauss

Note: 5. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.

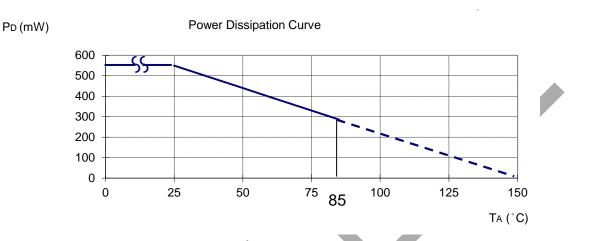




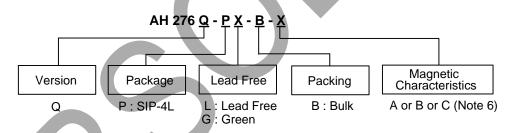


## **Performance Characteristics**

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	95	100
P <sub>D</sub> (mW)	550	440	396	352	308	286	264	242	220
T <sub>A</sub> (°C)	105	110	115	120	125	130	135	140	150
P <sub>D</sub> (mW)	198	176	154	132	110	88	66	44	0



# **Ordering Information**

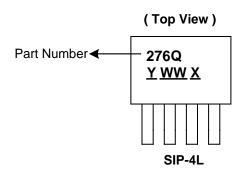


Part Number	Package	Packaging Bulk M		Magnetic	
Part Number	Code	Fackaging	Quantity	Part Number Suffix	Characteristics
AH276Q-PL-B-A	Р	SIP-4L	1000	-B	А
AH276Q-PL-B-B	Р	SIP-4L	1000	-B	В
AH276Q-PL-B-C	Р	SIP-4L	1000	-B	С
AH276Q-PG-B-A	Р	SIP-4L	1000	-B	Α
AH276Q-PG-B-B	Р	SIP-4L	1000	-В	В
AH276Q-PG-B-C	Р	SIP-4L	1000	-В	С

Note: 6. Please refer to page 3 (Magnetic Characteristics table).



## **Marking Information**



Y: Year: 0~9

WW: Week: 01~52, "52" represents

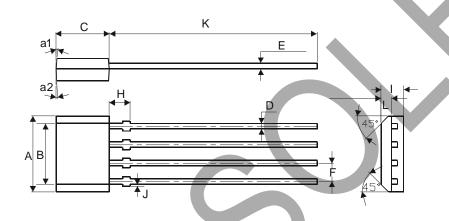
52 and 53 week

X: Internal Code: a~z: Lead Free

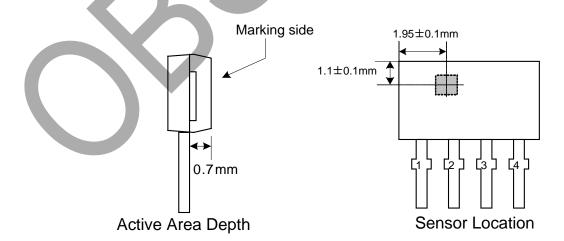
A~Z: Green

## Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SIP-4	
Dim	Min	Max
Α	5.12	5.32
В	4.10	4.30
С	3.55	3.75
D	0.38	0.44
Е	0.35	0.41
F	1.24	1.30
Н	1.32	1.52
ı	1.45	1.65
J	0.00	0.2
K	13.00	15.5
L	0.63	0.83
a1	3°	5°
a2	4°	7°
All Dim	ensions	in mm





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